







SN54LVC74A, SN74LVC74A

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# SNx4LVC74A Dual Positive-Edge-Triggered D-Type Flip-Flops With Clear and Preset

#### 1 Features

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- Operate From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Maximum t<sub>pd</sub> of 5.2 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >2 V at V<sub>CC</sub> = 3.3 V,  $T_A$  = 25°C
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

#### Applications 2

- Servers
- Medical, Healthcare, and Fitness
- **Telecom Infrastructures**
- TVs, Set-Top Boxes, and Audio
- Test and Measurement
- Industrial Transport
- Wireless Infrastructure
- Enterprise Switching
- Motor Drives
- Factory Automation and Control

#### 3 Description

The SNx4LVC74A devices integrate two positiveedge triggered D-type flip-flops in one convenient device.

The SN54LVC74A is designed for 2.7-V to 3.6-V  $V_{CC}$ operation, and the SN74LVC74A is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

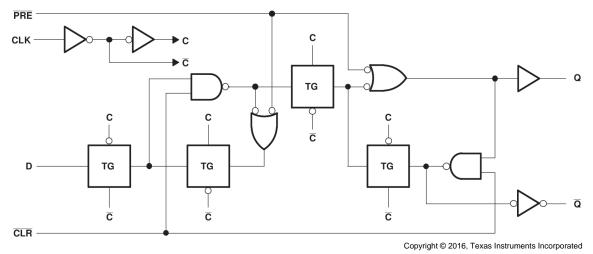
A low level at the preset ( $\overline{PRE}$ ) or clear ( $\overline{CLR}$ ) inputs sets or resets the outputs, regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the data (D) input meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

The data I/Os and control inputs are overvoltage tolerant. This feature allows the use of these devices for down-translation in a mixed-voltage environment.

Device Information<sup>(1)</sup>

| Device miormation |  |  |  |  |  |  |  |  |
|-------------------|--|--|--|--|--|--|--|--|
| PACKAGE           | BODY SIZE (NOM)  |  |  |  |  |  |  |  |
| LCCC (20)         | 8.89 mm × 8.89 mm  |  |  |  |  |  |  |  |
| CDIP (14)         | 19.56 mm × 6.67 mm   |  |  |  |  |  |  |  |
| CFP (14)          | 9.21 mm × 5.97 mm  |  |  |  |  |  |  |  |
| SOIC (14)         | 8.65 mm × 3.91 mm  |  |  |  |  |  |  |  |
| SSOP (14)         | 6.20 mm × 5.30 mm  |  |  |  |  |  |  |  |
| SO (14)           | 10.30 mm × 5.30 mm   |  |  |  |  |  |  |  |
| TSSOP (14)        | 5.00 mm × 4.40 mm  |  |  |  |  |  |  |  |
| VQFN (14)         | 3.50 mm × 3.50 mm  |  |  |  |  |  |  |  |
|                   | PACKAGE        LCCC (20)        CDIP (14)        CFP (14)        SOIC (14)        SSOP (14)        SO (14)        TSSOP (14) |  |  |  |  |  |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



### Logic Diagram, Each Flip-Flop (Positive Logic)

An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production





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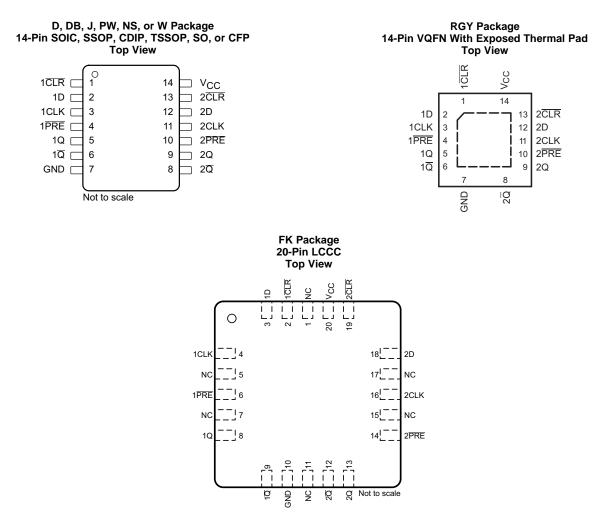
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**4 Revision History** NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| CI | hanges from Revision T (July 2013) to Revision U  | Page |
|----|---|------|
| •  | Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section | 1    |
| •  | Changed Package thermal impedance, R <sub>θJA</sub> , values in <i>Thermal Information:</i> SN74LVC74A From: 86 To: 93.7 (D), From: 96 To: 107.3 (DB), From: 76 To: 90.3 (NS), From: 113 To: 121.7 (PW), and From: 47 To: 54.9 (RGY)  | 5    |
| C  | hanges from Revision S (May 2005) to Revision T   | Page |
| •  | Extended maximum temperature operating range from 85°C to 125°C   | 4    |



### 5 Pin Configuration and Functions



**Pin Functions** 

|                 | PIN   |                     |     |  |
|-----------------|---|---------------------|-----|--|
| NAME            | CDIP, CFP, PDIP, SO, SOIC,<br>SSOP, TSSOP, VQFN | LCCC                | I/O | DESCRIPTION  |
| 1CLK            | 3   | 4                   | I   | Channel 1 clock input                                  |
| 1CLR            | 1   | 2                   | I   | Channel 1 clear input. Pull low to set Q output low.   |
| 1D              | 2   | 3                   | I   | Channel 1 data input                                   |
| 1PRE            | 4   | 6                   | I   | Channel 1 preset input. Pull low to set Q output high. |
| 1Q              | 5   | 8                   | 0   | Channel 1 output                                       |
| 1 <del>Q</del>  | 6   | 9                   | 0   | Channel 1 inverted output                              |
| 2CLK            | 11  | 16                  | I   | Channel 2 clock input                                  |
| 2CLR            | 13  | 19                  | I   | Channel 2 clear input. Pull low to set Q output low.   |
| 2D              | 12  | 18                  | I   | Channel 2 data input                                   |
| 2PRE            | 10  | 14                  | I   | Channel 2 preset input. Pull low to set Q output high. |
| 2Q              | 9   | 13                  | 0   | Channel 2 output                                       |
| 2 <del>Q</del>  | 8   | 12                  | 0   | Channel 2 Inverted output                              |
| GND             | 7   | 10                  | _   | Ground   |
| NC              | —   | 1, 5, 7, 11, 15, 17 |     | No connect   |
| V <sub>CC</sub> | 14  | 20                  |     | Supply   |

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### 6 Specifications

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|   |                    | MIN  | MAX                   | UNIT |
|---|--------------------|------|-----------------------|------|
| Supply voltage, V <sub>CC</sub>                   |                    | -0.5 | 6.5                   | V    |
| Input voltage, VI <sup>(2)</sup>                  |                    | -0.5 | 6.5                   | V    |
| Output voltage, V <sub>O</sub> <sup>(2)(3)</sup>  |                    | -0.5 | V <sub>CC</sub> + 0.5 | V    |
| Input clamp current, I <sub>IK</sub>              | V <sub>1</sub> < 0 |      | -50                   | mA   |
| Output clamp current, I <sub>OK</sub>             | V <sub>O</sub> < 0 |      | -50                   | mA   |
| Continuous output current, I <sub>O</sub>         |                    |      | ±50                   | mA   |
| Continuous current through V <sub>CC</sub> or GND |                    |      | ±100                  | mA   |
| Storage temperature, T <sub>stg</sub>             |                    | -65  | 150                   | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V<sub>CC</sub> is provided in *Recommended Operating Conditions*.

#### 6.2 ESD Ratings

|                    |                         |  | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| V                  | Flastrastatia diasharga | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 | V    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

#### 6.3 Recommended Operating Conditions

see<sup>(1)</sup>

|                     |                                    |  |            | MIN                  | MAX                  | UNIT |  |
|---------------------|------------------------------------|--|------------|----------------------|----------------------|------|--|
|                     | Supply voltage                     | Operating                                  | SN54LVC74A | 2                    | 3.6                  |      |  |
| $V_{CC}$            |                                    | Operating                                  | SN74LVC74A | 1.65                 | 3.6                  | V    |  |
|                     |                                    | Data retention only                        |            | 1.5                  |                      |      |  |
|                     |                                    | $V_{CC}$ = 1.65 V to 1.95 V                | SN74LVC74A | $0.65 \times V_{CC}$ |                      |      |  |
| VIH                 | High-level input voltage           | $V_{CC}$ = 2.3 V to 2.7 V                  | SN74LVC74A | 1.7                  |                      | V    |  |
|                     |                                    | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ |            | 2                    |                      |      |  |
|                     |                                    | $V_{CC}$ = 1.65 V to 1.95 V                | SN74LVC74A |                      | $0.35 \times V_{CC}$ |      |  |
| VIL                 | Low-level input voltage            | $V_{CC}$ = 2.3 V to 2.7 V                  | SN74LVC74A |                      | 0.7                  | V    |  |
|                     |                                    | $V_{CC} = 2.7 V \text{ to } 3.6 V$         |            |                      | 0.8                  |      |  |
| VI                  | Input voltage                      |  |            | 0                    | 5.5                  | V    |  |
| Vo                  | Output voltage                     |  |            | 0                    | V <sub>CC</sub>      | V    |  |
|                     |                                    | V <sub>CC</sub> = 1.65 V                   | SN74LVC74A |                      | -4                   |      |  |
|                     | Link laurel autout aumant          | V <sub>CC</sub> = 2.3 V                    | SN74LVC74A |                      | -8                   |      |  |
| I <sub>OH</sub>     | High-level output current          | $V_{CC} = 2.7 V$                           |            |                      | -12                  | mA   |  |
|                     |                                    | $V_{CC} = 3 V$                             |            |                      | -24                  |      |  |
|                     |                                    | V <sub>CC</sub> = 1.65 V                   | SN74LVC74A |                      | 4                    |      |  |
|                     | I and land and and an una at       | V <sub>CC</sub> = 2.3 V                    | SN74LVC74A |                      | 8                    |      |  |
| I <sub>OL</sub>     | Low-level output current           | $V_{CC} = 2.7 V$                           |            |                      | 12                   | mA   |  |
|                     |                                    | $V_{CC} = 3 V$                             |            |                      | 24                   |      |  |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | )  |            |                      | 10                   | ns/V |  |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs (SCBA004).



#### **Recommended Operating Conditions (continued)**

see<sup>(1)</sup>

|                |                                |            | MIN | MAX | UNIT |
|----------------|--------------------------------|------------|-----|-----|------|
| T <sub>A</sub> | Operating free-air temperature | SN54LVC74A | -55 | 125 | °C   |
|                |                                | SN74LVC74A | -40 | 125 |      |

#### 6.4 Thermal Information: SN74LVC74A

|                               |  | SN74LVC74A  |              |            |               |               |      |
|-------------------------------|--|-------------|--------------|------------|---------------|---------------|------|
| THERMAL METRIC <sup>(1)</sup> |  | D<br>(SOIC) | DB<br>(SSOP) | NS<br>(SO) | PW<br>(TSSOP) | RGY<br>(VQFN) | UNIT |
|                               |  | 14 PINS     | 14 PINS      | 14 PINS    | 14 PINS       | 14 PINS       |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 93.7        | 107.3        | 90.3       | 121.7         | 54.9          | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 54.8        | 59.2         | 48.1       | 50.3          | 52.2          | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 48          | 54.6         | 49.1       | 63.4          | 30.8          | °C/W |
| ΨJT                           | Junction-to-top characterization parameter   | 20.3        | 24.1         | 17.9       | 6.2           | 2.4           | °C/W |
| ΨЈВ                           | Junction-to-board characterization parameter | 47.7        | 54.1         | 48.8       | 62.8          | 30.9          | °C/W |
| R <sub>0JC(bot)</sub>         | Junction-to-case (bottom) thermal resistance |             | —            | _          | _             | 12.5          | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

#### 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER                 |   | TEST CONDITIONS   | MIN                   | TYP  | MAX  | UNIT |  |
|-----------------|---------------------------|---|---|-----------------------|------|------|------|--|
|                 |                           | L = 100 uA  | $V_{CC}$ = 1.65 V to 3.6 V and $T_A$ = –55°C to 125°C (SN54LVC74A only)                 | V <sub>CC</sub> - 0.2 |      |      |      |  |
|                 |                           | I <sub>OH</sub> = −100 μA                                     | $V_{CC}$ = 2.7 V to 3.6 V and $T_A$ = $-40^\circ C$ to 125°C (SN74LVC74A only)          | $V_{CC} - 0.2$        |      |      |      |  |
| V <sub>OH</sub> | High-level output voltage | $I_{OH} = -4 \text{ mA}, V_{CC} = (SN74LVC74A \text{ only})$  | = 1.65 V, and T <sub>A</sub> = –40°C to 125°C<br>/)                                     | 1.2                   |      |      | V    |  |
| - OH            |                           | $I_{OH} = -8 \text{ mA}, V_{CC} = (SN74LVC74A \text{ only})$  | = 2.3 V, and T <sub>A</sub> = –40°C to 125°C<br>/)                                      | 1.7                   |      |      | -    |  |
|                 |                           | 1 – 12 mA   | $V_{CC} = 2.7 V$  | 2.2                   |      |      |      |  |
|                 |                           | I <sub>OH</sub> = -12 mA                                      | $V_{CC} = 3 V$  | 2.4                   |      |      |      |  |
|                 |                           | $I_{OH} = -24 \text{ mA}, \text{ V}_{CC}$                     | = 3 V   | 2.2                   |      |      |      |  |
|                 |                           | 100.04  | $V_{CC}$ = 1.65 V to 3.6 V, and $T_{A}$ = –40°C to 125°C (SN74LVC74A only)              |                       |      | 0.2  |      |  |
|                 |                           | I <sub>OL</sub> = 100 μA                                      | $V_{CC}$ = 2.7 V to 3.6 V and $T_A$ = –55°C to 125°C (SN54LVC74A only)                  |                       |      | 0.2  | 1    |  |
| V <sub>OL</sub> | Low-level output voltage  | $I_{OL} = 4 \text{ mA}, V_{CC} = (SN74LVC74A \text{ only})$   | 1.65 V, and $T_A = -40^{\circ}$ C to 125°C<br>/)  |                       |      | 0.45 | V    |  |
|                 |                           | $I_{OL} = 8 \text{ mA}, V_{CC} = 3 \text{ (SN74LVC74A only)}$ | 2.3 V, and T <sub>A</sub> = -40°C to 125°C<br>/)  |                       |      | 0.7  |      |  |
|                 |                           | I <sub>OL</sub> = 12 mA, V <sub>CC</sub> = 2.7 V              |   |                       | 0.4  | 0.4  |      |  |
|                 |                           | $I_{OL}$ = 24 mA, $V_{CC}$ =                                  |   |                       | 0.55 |      |      |  |
| I <sub>I</sub>  | Input current             | $V_{I} = 5.5 V \text{ or GND},$                               | $V_{I} = 5.5 \text{ V or GND}, V_{CC} = 3.6 \text{ V}$                                  |                       |      | ±5   | μA   |  |
| I <sub>CC</sub> | Supply current            | $V_I = V_{CC} \text{ or } GND, I$                             | $V_{\rm I} = V_{\rm CC} \text{ or GND, } I_{\rm O} = 0, V_{\rm CC} = 3.6 \text{ V}$     |                       |      | 10   | μA   |  |
| $\Delta I_{CC}$ | Change in supply current  | One input at V <sub>CC</sub> - V <sub>CC</sub> = 2.7 V to 3.6 | ne input at V_{CC} – 0.6 V, other inputs at V_{CC} or GND, and $_{CC}$ = 2.7 V to 3.6 V |                       |      | 500  | μA   |  |
| Ci              | Input capacitance         | $V_I = V_{CC} \text{ or } GND, V_{CC}$                        | $/_{\rm CC} = 3.3 \text{ V}, \text{ T}_{\rm A} = 25^{\circ} \text{C}$                   |                       | 5    |      | pF   |  |

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EXAS

#### 6.6 Timing Requirements: SN54LVC74A

#### over recommended operating free-air temperature range (unless otherwise noted; see Figure 3)

|                    |                            |  |  | MIN              | MAX | UNIT |  |
|--------------------|----------------------------|--|--|------------------|-----|------|--|
| f <sub>clock</sub> | Clock froquency            | $V_{CC} = 2.7 V$                           |  |                  | 83  | M⊔→  |  |
|                    | Clock frequency            | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |  |                  | 100 | MHz  |  |
| t <sub>w</sub> Pu  | Pulse duration             | PRE or CLR low                             |  | 3.3              |     | 20   |  |
|                    | Puise duration             | CLK high or low                            | CLK high or low                            |                  |     | ns   |  |
|                    | Setup time before CLK↑     | Data                                       | Data                                       | $V_{CC} = 2.7 V$ | 3.4 |      |  |
|                    |                            |  | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 3                |     | ns   |  |
| t <sub>su</sub>    |                            | PRE or CLR inactive                        | $V_{CC} = 2.7 V$                           | 2.2              |     |      |  |
|                    |                            | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |  | 2                |     |      |  |
| t <sub>h</sub>     | Hold time, data after CLK↑ |  |  | 1                |     | ns   |  |

#### 6.7 Timing Requirements: SN74LVC74A

over recommended operating free-air temperature range (unless otherwise noted; see Figure 3)

|                    |                            |                                  |   | MIN | MAX | UNIT |
|--------------------|----------------------------|----------------------------------|---|-----|-----|------|
| f <sub>clock</sub> | Clock frequency            | V <sub>CC</sub> = 1.8 V or 2.5 V |   |     | 83  | MHz  |
|                    |                            | PRE or CLR low                   | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | 4.1 |     |      |
|                    | Dulas duration             | PRE OF CLR IOW                   | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | 3.3 |     |      |
| t <sub>w</sub>     | Pulse duration             | CI K high or low                 | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | 4.1 |     | ns   |
|                    |                            | CLK high or low                  | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | 3.3 |     |      |
|                    |                            | Data                             | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | 3.6 |     |      |
|                    | Cotup time hofers CLIA     | Data                             | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | 2.3 |     |      |
| t <sub>su</sub>    | Setup time before CLK↑     | PRE or CLR inactive              | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | 2.7 |     | ns   |
|                    |                            | PRE OF GLR INACTIVE              | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | 1.9 |     |      |
| t <sub>h</sub>     | Hold time, data after CLK↑ | $V_{CC}$ = 1.8 V or 2.5 V        |   | 1   |     | ns   |

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#### 6.8 Timing Requirements: SN74LVC74A, -40°C to 125°C and -40°C to 85°C

over recommended operating free-air temperature range (unless otherwise noted; see Figure 3)

|                    |                               |  |  |  | MIN | MAX | UNIT |
|--------------------|-------------------------------|--|--|--|-----|-----|------|
|                    |                               | $T_A = -40^{\circ}C$ to                        | V <sub>CC</sub> = 2.7 V                    |  |     | 83  |      |
| f <sub>clock</sub> | Clock frequency               | 125°C  | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |  |     | 100 | MHz  |
|                    |                               | $T_{A} = -40^{\circ}C \text{ to } 85^{\circ}C$ | C and $V_{CC}$ = 3.3 V ± 0.3 V             |  |     | 150 |      |
|                    | Dulas duration                | PRE or CLR low                                 | $V_{CC} = 2.7 \text{ V or } 3.3 \text{ V}$ |  | 3.3 |     |      |
| t <sub>w</sub>     | Pulse duration                | CLK high or low                                | $V_{CC} = 2.7 \text{ V or } 3.3 \text{ V}$ |  | 3.3 |     | ns   |
|                    |                               |  | T 40%C to 125%C                            | $V_{CC} = 2.7 V$                           | 3.4 |     |      |
|                    |                               | Data   | $T_A = -40^{\circ}C$ to $125^{\circ}C$     | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 3   |     |      |
|                    | Catura tima hafana CLIKA      |  | $T_A = -40^{\circ}C$ to 85°C and           | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 3   |     |      |
| t <sub>su</sub>    | Setup time before CLK↑        |  | T 40%0 to 405%0                            | $V_{CC} = 2.7 V$                           | 2.2 |     | ns   |
|                    |                               | PRE or CLR<br>inactive                         | $T_A = -40^{\circ}C$ to $125^{\circ}C$     | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 2   |     |      |
|                    |                               |  | $T_A = -40^{\circ}C$ to 85°C and           | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 2   |     |      |
| t <sub>h</sub>     | Hold time, data after<br>CLK↑ | V <sub>CC</sub> = 2.7 V or 3.3                 | V  |  | 1   |     | ns   |

#### 6.9 Switching Characteristics: SN54LVC74A

over recommended operating free-air temperature range (unless otherwise noted; see Figure 3)

|                 | PARAMETER           | FROM<br>(INPUT) | TO<br>(OUTPUT)      | TEST CONDITIONS                            | MIN | МАХ | UNIT   |
|-----------------|---------------------|-----------------|---------------------|--|-----|-----|--------|
| £               | Maximum clock       |                 |                     | $V_{CC} = 2.7 V$                           | 83  |     | MHz    |
| Imax            | frequency           |                 |                     | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 100 |     | IVITIZ |
|                 |                     |                 |                     | $V_{CC} = 2.7 V$                           |     | 6   |        |
|                 | Propagation (delay) | elav)           | <u> </u>            | V <sub>CC</sub> = 2.7 V                    | 1   | 5.2 |        |
| τ <sub>pd</sub> | time                | PRE or CLR      | Q or $\overline{Q}$ | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |     | 6.4 | ns     |
|                 |                     | PRE OF CLR      |                     | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 1   | 5.4 |        |

#### 6.10 Switching Characteristics: SN74LVC74A

over recommended operating free-air temperature range (unless otherwise noted; see Figure 3)

|                  | PARAMETER                  | FROM<br>(INPUT) | TO<br>(OUTPUT)   | TEST CONDITIONS                             | MIN | МАХ | UNIT |
|------------------|----------------------------|-----------------|--|---|-----|-----|------|
| f <sub>max</sub> | Maximum clock<br>frequency | _               | _  |   | 83  |     | MHz  |
|                  |                            | CLKPRE          |  | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | 1   | 7.1 |      |
|                  | Propagation (delay)        | CLKPRE          | Q or Q   | $V_{CC} = 2.5 V \pm 0.2 V$                  | 1   | 4.4 |      |
| τ <sub>pd</sub>  | time                       |                 | Q OF Q   | V <sub>CC</sub> = 1.8 V ± 0.15 V            | 1   | 6.9 | ns   |
|                  |                            |                 | or $\overline{\text{CLR}}$ $V_{\text{CC}} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | 1   | 4.6 |     |      |

### 6.11 Switching Characteristics: SN74LVC74A, -40°C to 125°C and -40°C to 85°C

over recommended operating free-air temperature range (unless otherwise noted; see Figure 3)

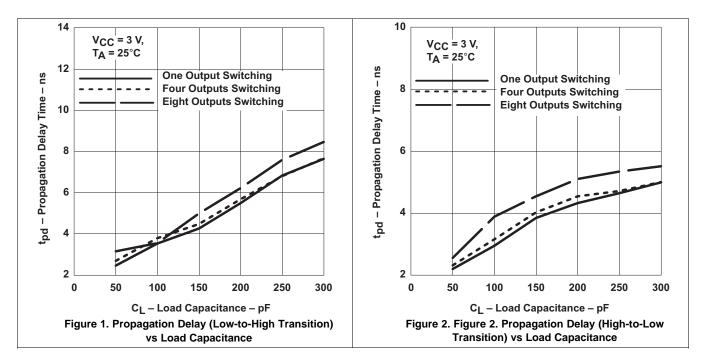
|                    | PARAMETER                  | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CC                                   | ONDITIONS                                  | MIN | МАХ | UNIT |
|--------------------|----------------------------|-----------------|----------------|---|--|-----|-----|------|
|                    |                            |                 |                | T 40%C to 125%C                           | V <sub>CC</sub> = 2.7 V                    | 83  |     |      |
| f <sub>max</sub>   | Maximum clock<br>frequency | —               | _              | $T_A = -40^{\circ}C$ to $125^{\circ}C$    | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | 100 |     | MHz  |
|                    | nequency                   |                 |                | $T_A = -40^{\circ}C$ to 85°C and          | 40°C to 85°C and $V_{CC}$ = 3.3 V ± 0.3 V  |     |     |      |
|                    |                            |                 |                |   | V <sub>CC</sub> = 2.7 V                    | 1   | 6   |      |
|                    |                            | CLK             |                | $T_A = -40^{\circ}C$ to $125^{\circ}C$    | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |     | 5.2 |      |
|                    | Propagation (delay)        |                 | Q or Q         | $T_A = -40^{\circ}C$ to $85^{\circ}C$ and | $V_{CC} = 3.3 V \pm 0.3 V$                 | 1   | 5.2 | ~~   |
| t <sub>pd</sub>    | time                       |                 | QUIQ           | T <sub>A</sub> = -40°C to 125°C           | $V_{CC} = 2.7 V$                           | 1   | 6.4 | ns   |
|                    |                            | PRE or CLR      |                | $T_{A} = -40^{\circ}$ C 10 125°C          | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |     | 5.4 |      |
|                    |                            |                 |                | $T_A = -40^{\circ}C$ to 85°C and          | $V_{\rm CC} = 3.3 \ V \pm 0.3 \ V$         | 1   | 5.4 |      |
| t <sub>sk(o)</sub> | Skew (time), output        | —               | _              | $T_A = -40^{\circ}C$ to 85°C and          | $V_{CC} = 3.3 V \pm 0.3 V$                 |     | 1   | ns   |

#### 6.12 Operating Characteristics

T<sub>A</sub> = 25°C

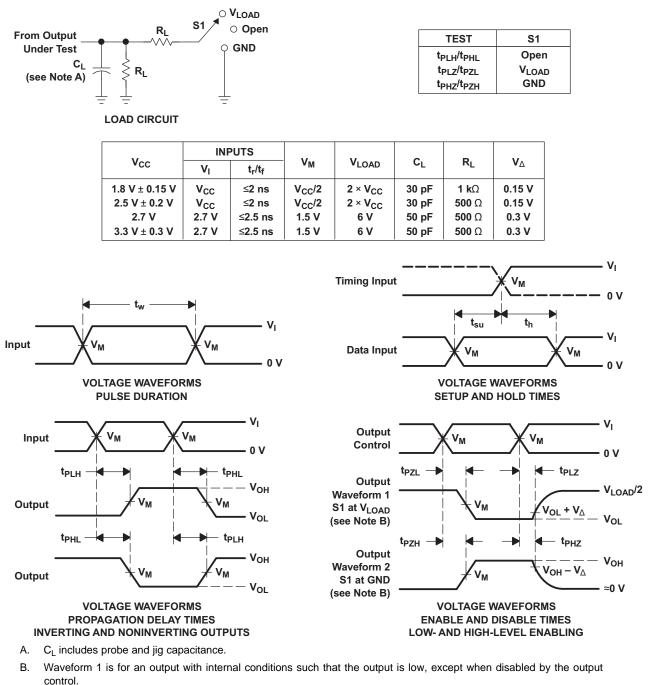
|                 | PARAMETER                                   | TEST       | CONDITIONS              | TYP | UNIT |
|-----------------|---|------------|-------------------------|-----|------|
|                 |   |            | V <sub>CC</sub> = 1.8 V | 24  |      |
| C <sub>pd</sub> | Power dissipation capacitance per flip-flop | f = 10 MHz | $V_{CC} = 2.5 V$        | 24  | pF   |
|                 |   |            | $V_{CC} = 3.3 V$        | 26  |      |

#### 6.13 Typical Characteristics





#### 7 Parameter Measurement Information



Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>0</sub> = 50  $\Omega$ .
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 3. Load Circuit and Voltage Waveforms

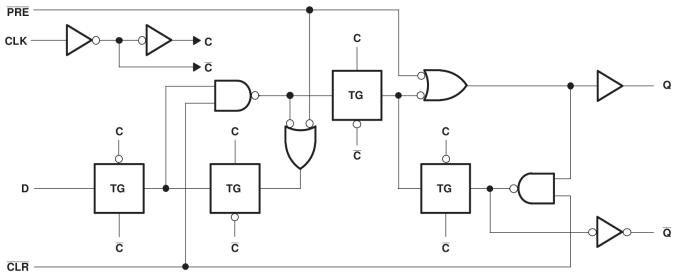
#### 8 Detailed Description

#### 8.1 Overview

The SNx4LVC74A devices feature two independent positive-edge triggered D flip-flops. Integrated preset (PRE) and clear (CLR) functions allow for easy setup and control during operation.

The SN54LVC74A device is specified from  $-55^{\circ}$ C to  $125^{\circ}$ C, and the SN74LVC74A device is specified from  $-40^{\circ}$ C to  $125^{\circ}$ C.

#### 8.2 Functional Block Diagram



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#### 8.3 Feature Description

A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs, regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the data (D) input meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

#### 8.4 Device Functional Modes

Table 1 describes the SNx4LVC74A functionality and interactions between the PRE, CLR, CLK, and D inputs.

|     | INP | UTS      |   | OUTI                  | PUTS             |
|-----|-----|----------|---|-----------------------|------------------|
| PRE | CLR | CLK      | D | Q                     | Q                |
| L   | Н   | Х        | Х | Н                     | L                |
| Н   | L   | Х        | Х | L                     | Н                |
| L   | L   | Х        | Х | H <sup>(1)</sup>      | H <sup>(1)</sup> |
| Н   | Н   | <b>↑</b> | н | Н                     | L                |
| Н   | Н   | <b>↑</b> | L | L                     | Н                |
| Н   | Н   | L        | Х | <b>Q</b> <sub>0</sub> | $\overline{Q}_0$ |

#### **Table 1. Function Table**

(1) This configuration is nonstable; that is, it does not persist when PRE or CLR returns to its inactive (high) level.



#### 9 Application and Implementation

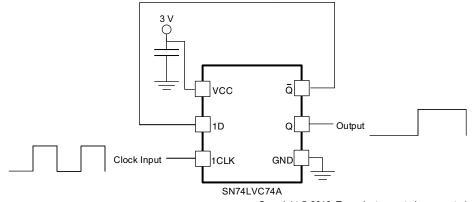
#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

A common application for the SN74LVC74A is a frequency divider. By connecting the  $\overline{Q}$  output to the D input, the Q output toggles states on each positive edge of the incoming clock signal. Because it takes two positive edges, or two clock pulses, to complete one complete pulse on the output (one pulse to toggle from low to high, another to toggle from high to low), the incoming clock frequency is effectively divided by two.

#### 9.2 Typical Application



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Figure 4. Frequency Divider

#### 9.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Avoid bus contention because it can drive currents in excess of maximum limits. The high drive also creates fast edges into light loads, so consider routing and load conditions to prevent ringing.

#### 9.2.2 Detailed Design Procedure

- 1. Recommended input conditions:
  - For rise time and fall time specification, see ( $\Delta t/\Delta V$ ) in *Recommended Operating Conditions*.
  - For specified high and low levels, see (V<sub>IH</sub> and V<sub>IL</sub>) in *Recommended Operating Conditions*.
  - Inputs are overvoltage tolerant allowing them to go as high as (V<sub>I</sub> max) in *Recommended Operating Conditions* at any valid V<sub>CC</sub>.
- 2. Recommended maximum output conditions:
  - Load currents must not exceed (I<sub>O</sub> max) per output and must not exceed (Continuous current through V<sub>CC</sub> or GND) total current for the part. These limits are located in *Absolute Maximum Ratings*.
  - Outputs must not be pulled above V<sub>CC</sub>.

#### SN54LVC74A, SN74LVC74A

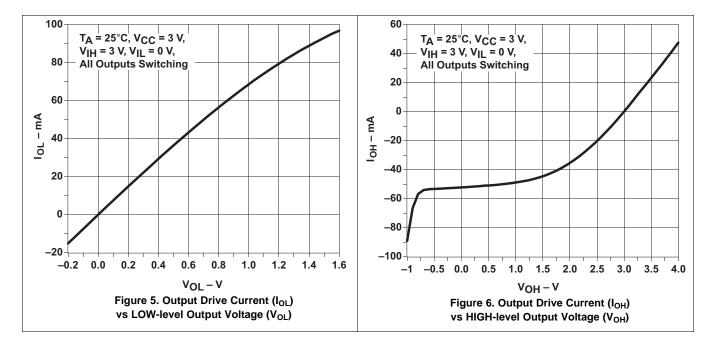
SCAS287U-JANUARY 1993-REVISED JANUARY 2017



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#### **Typical Application (continued)**

#### 9.2.3 Application Curves





#### **10** Power Supply Recommendations

The power supply may be any voltage between the minimum and maximum supply voltage rating located in *Recommended Operating Conditions*.

Each V<sub>CC</sub> terminal must have a good bypass capacitor to prevent power disturbance. A  $0.1-\mu$ F capacitor is recommended for devices with a single supply. If there are multiple V<sub>CC</sub> terminals, then  $0.01-\mu$ F or  $0.022-\mu$ F capacitors are recommended for each power terminal. It is permissible to parallel multiple bypass capacitors to reject different frequencies of noise. Multiple bypass capacitors may be paralleled to reject different frequencies of noise. The bypass capacitor must be installed as close to the power terminal as possible for the best results.

#### 11 Layout

#### 11.1 Layout Guidelines

Inputs must not float when using multiple bit logic devices. In many cases, functions or parts of functions of digital logic devices are unused. Some examples include situations when only two inputs of a triple-input AND gate are used, or when only 3 of the 4-buffer gates are used. Such input pins must not be left unconnected because the undefined voltages at the outside connections result in undefined operational states.

Specified in Figure 7 are rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that must be applied to any particular unused input depends on the function of the device. Generally, they are tied to GND or  $V_{CC}$ , whichever makes more sense or is more convenient.

#### 11.2 Layout Example



Figure 7. Layout Diagram

TEXAS INSTRUMENTS

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#### **12 Device and Documentation Support**

#### **12.1** Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

Implications of Slow or Floating CMOS Inputs (SCBA004)

#### 12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

| PARTS      | PRODUCT FOLDER | ORDER NOW  | TECHNICAL<br>DOCUMENTS | TOOLS &<br>SOFTWARE | SUPPORT & COMMUNITY |
|------------|----------------|------------|------------------------|---------------------|---------------------|
| SN54LVC74A | Click here     | Click here | Click here             | Click here          | Click here          |
| SN74LVC74A | Click here     | Click here | Click here             | Click here          | Click here          |

#### Table 2. Related Links

#### 12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 12.4 Community Resource

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E<sup>™</sup> Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support TI's Design Support** Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

#### 12.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 12.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

#### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



6-Feb-2020

### PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5)                  | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|--|---------|
| 5962-9761601Q2A  | ACTIVE | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type | -55 to 125   | 5962-<br>9761601Q2A<br>SNJ54LVC<br>74AFK | Samples |
| 5962-9761601QCA  | ACTIVE | CDIP         | J                  | 14   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | 5962-9761601QC<br>A<br>SNJ54LVC74AJ      | Samples |
| 5962-9761601QDA  | ACTIVE | CFP          | W                  | 14   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | 5962-9761601QD<br>A<br>SNJ54LVC74AW      | Samples |
| 5962-9761601VDA  | ACTIVE | CFP          | W                  | 14   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | 5962-9761601VD<br>A<br>SNV54LVC74AW      | Samples |
| SN74LVC74AD      | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LVC74A                                   | Samples |
| SN74LVC74ADBR    | ACTIVE | SSOP         | DB                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74ADBRG4  | ACTIVE | SSOP         | DB                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74ADE4    | ACTIVE | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LVC74A                                   | Samples |
| SN74LVC74ADR     | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LVC74A                                   | Samples |
| SN74LVC74ADRE4   | ACTIVE | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LVC74A                                   | Samples |
| SN74LVC74ADT     | ACTIVE | SOIC         | D                  | 14   | 250            | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LVC74A                                   | Samples |
| SN74LVC74ANSR    | ACTIVE | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LVC74A                                   | Samples |
| SN74LVC74APW     | ACTIVE | TSSOP        | PW                 | 14   | 90             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74APWG4   | ACTIVE | TSSOP        | PW                 | 14   | 90             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74APWR    | ACTIVE | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU   SN      | Level-1-260C-UNLIM | -40 to 125   | LC74A                                    | Samples |



### PACKAGE OPTION ADDENDUM

6-Feb-2020

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp       | Op Temp (°C) | Device Marking<br>(4/5)                  | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|-------------------------|---------------------|--------------|--|---------|
| SN74LVC74APWRE4  | ACTIVE | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM  | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74APWRG4  | ACTIVE | TSSOP        | PW                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM  | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74APWT    | ACTIVE | TSSOP        | PW                 | 14   | 250            | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM  | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74APWTG4  | ACTIVE | TSSOP        | PW                 | 14   | 250            | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-1-260C-UNLIM  | -40 to 125   | LC74A                                    | Samples |
| SN74LVC74ARGYR   | ACTIVE | VQFN         | RGY                | 14   | 3000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-2-260C-1 YEAR | -40 to 125   | LC74A                                    | Samples |
| SNJ54LVC74AFK    | ACTIVE | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE              | N / A for Pkg Type  | -55 to 125   | 5962-<br>9761601Q2A<br>SNJ54LVC<br>74AFK | Samples |
| SNJ54LVC74AJ     | ACTIVE | CDIP         | J                  | 14   | 1              | TBD                        | Call TI                 | N / A for Pkg Type  | -55 to 125   | 5962-9761601QC<br>A<br>SNJ54LVC74AJ      | Samples |
| SNJ54LVC74AW     | ACTIVE | CFP          | W                  | 14   | 1              | TBD                        | Call TI                 | N / A for Pkg Type  | -55 to 125   | 5962-9761601QD<br>A<br>SNJ54LVC74AW      | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



### PACKAGE OPTION ADDENDUM

6-Feb-2020

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LVC74A, SN54LVC74A-SP, SN74LVC74A :

- Catalog: SN74LVC74A, SN54LVC74A
- Automotive: SN74LVC74A-Q1, SN74LVC74A-Q1
- Enhanced Product: SN74LVC74A-EP, SN74LVC74A-EP
- Military: SN54LVC74A
- Space: SN54LVC74A-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

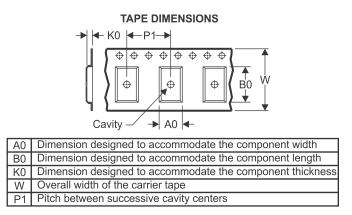
# PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



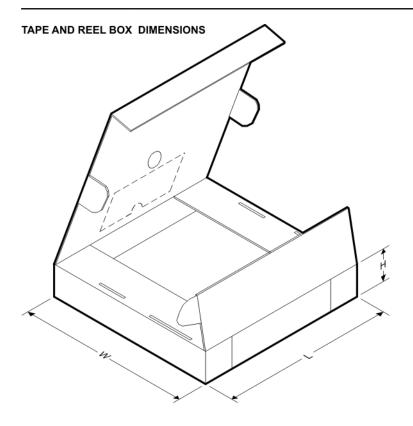
| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74LVC74ADR                | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LVC74ADT                | SOIC            | D                  | 14 | 250  | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LVC74ANSR               | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LVC74APWR               | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LVC74APWR               | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LVC74APWRG4             | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LVC74APWT               | TSSOP           | PW                 | 14 | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

TEXAS INSTRUMENTS

www.ti.com

# PACKAGE MATERIALS INFORMATION

20-Dec-2018



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC74ADR    | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74LVC74ADT    | SOIC         | D               | 14   | 250  | 210.0       | 185.0      | 35.0        |
| SN74LVC74ANSR   | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74LVC74APWR   | TSSOP        | PW              | 14   | 2000 | 364.0       | 364.0      | 27.0        |
| SN74LVC74APWR   | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74LVC74APWRG4 | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74LVC74APWT   | TSSOP        | PW              | 14   | 250  | 367.0       | 367.0      | 35.0        |

### **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

### DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



# **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# J0014A



# **PACKAGE OUTLINE**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



# J0014A

# **EXAMPLE BOARD LAYOUT**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



### **MECHANICAL DATA**



- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
- earrow Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated.
- The Pin 1 identifiers are either a molded, marked, or metal feature.
- G. Package complies to JEDEC MO-241 variation BA.



### RGY (S-PVQFN-N14)

### PLASTIC QUAD FLATPACK NO-LEAD

#### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



#### NOTE: All linear dimensions are in millimeters





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.

D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="http://www.ti.com">http://www.ti.com</a>.

- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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